

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	103	(@ad<"20011231") and 257/758. ccls. and (solder with ball\$1)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/26 16:38
L2	19	L1 and ((capacitor or passive or capacitance) with (dielectric or insulation or insulating))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/26 16:40
L3	12208	(@ad<"20011231") and (chip or die) and ((substrate or wafer or board) with (epoxy or glass)) and (cut or dice or saw or sawing or dicing)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/26 17:23
L4	1037	L3 and ((capacitor or passive or capacitance) with (dielectric or insulation or insulating))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/26 16:40
L5	3459	L3 and (capacitor or passive or capacitance)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/26 17:08
L6	619	L3 and (capacitor or passive or capacitance) and "438"/\$.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/26 16:41
L7	126	("5353498").URPN.	USPAT	OR	OFF	2005/11/26 17:08
L8	63	L7 and (capacitor or passive or capacitance)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/26 17:10
L9	25	L7 and (capacitor or passive or capacitance) and (@ad<"20011231") and (cut or saw or singulate or singulating or dicing or cutting or sawing)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/26 17:11

L10	8	("5353498"   "5422513"   "5497033"   "5527741"   "5703400"   "5745984"   "5998859"   "6091250").PN.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/11/26 17:12
L11	0	(@ad<"20011231") and microelectronics and (cut or dice or saw or sawing or dicing) and (capacitance or passive or capacitor)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/26 17:23
L12	1419	(@ad<"20011231") and microelectronics and (cut or dice or saw or sawing or dicing) and (capacitance or passive or capacitor)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/26 17:24
L13	1068	(@ad<"20011231") and microelectronics and (cut or dice or saw or sawing or dicing) and (capacitance or capacitor)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/26 17:27
L14	557	L13 and (dielectric or insulation or insulating)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/26 17:24
L15	660	L13 and (dielectric or insulation or insulating)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/26 17:24
L16	628	L15 not L6	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/26 17:25
L17	16	(@ad<"20011231") and 257/904. ccls. and (cut or dice or saw or sawing or dicing) and (capacitance or capacitor or passive)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/26 17:36
L18	8923	(@ad<"20011231") and wafer and (cut or dice or saw or sawing or dicing) and (capacitance or capacitor or passive)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/26 17:36

L19	0	(@ad<"20011231") and 257/666. ccls and (cut or dice or saw or sawing or dicing) and (capacitance or capacitor or passive)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/26 17:36
L20	147	(@ad<"20011231") and 257/666. ccls. and (cut or dice or saw or sawing or dicing) and (capacitance or capacitor or passive)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/26 17:48
L21	385	(@ad<"20011231") and 257/712, 723,701,787.ccls. and (cut or dice or saw or sawing or dicing) and (capacitance or capacitor or passive)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/26 17:48
L22	229	(@ad<"20011231") and 438/106-108.ccls. and (cut or dice or saw or sawing or dicing) and (capacitance or capacitor or passive)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/26 17:50
L23	6	(@ad<"20011231") and 438/381. ccls. and (cut or dice or saw or sawing or dicing) and (capacitance or capacitor or passive) and ball\$1	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/26 17:51
L24	438	(@ad<"20011231") and "438"/\$. ccls. and (cut or dice or saw or sawing or dicing) and (capacitance or capacitor or passive) and ball\$1	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/26 17:51